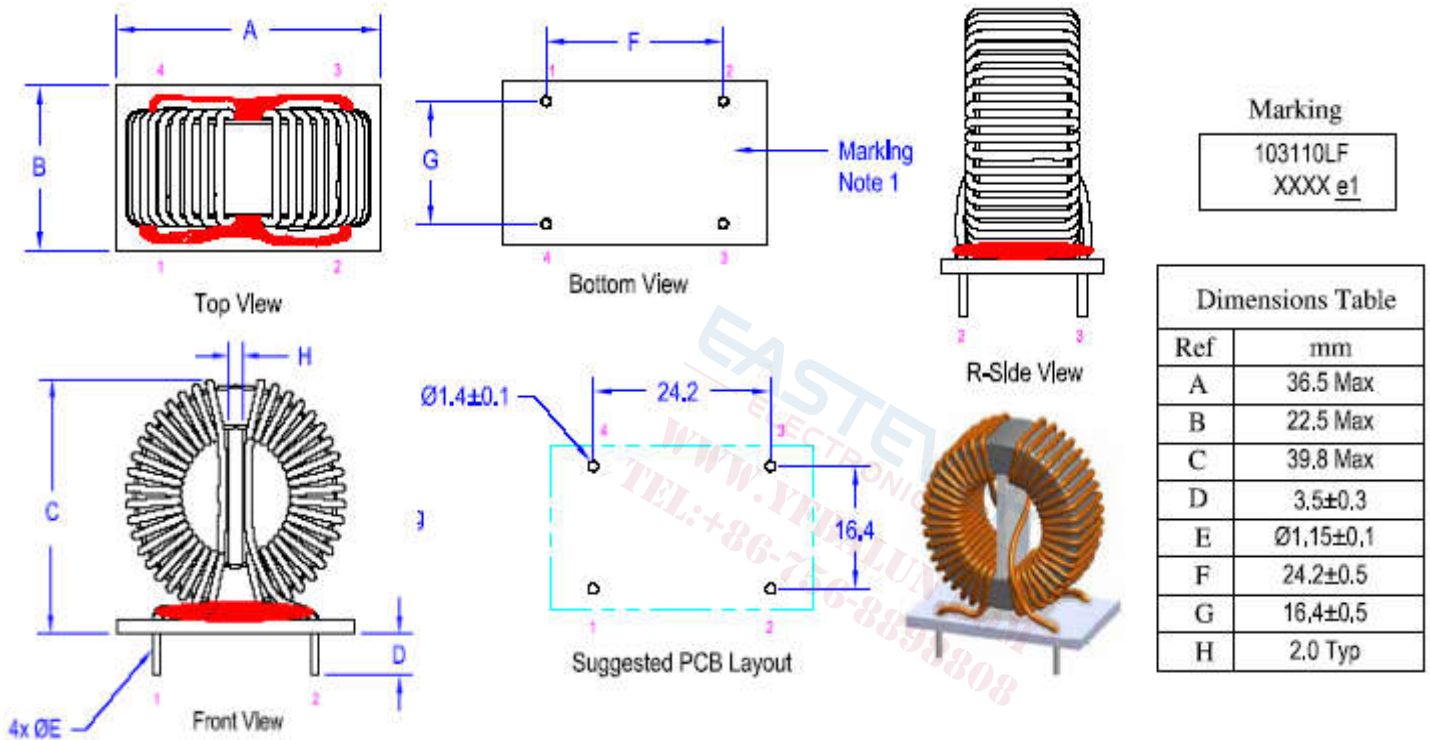




1、 DIMENSION DIAGRAM (Unit: mm)



2、 BILLOF MATERIALS

CORE:T31*19*13C R7K

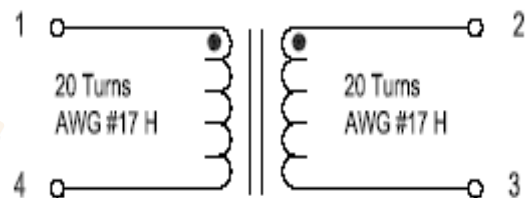
BASE:FR4 2.0mm THICK

WIRE:AWG(1.15mm) 2UEWH

EPOXY:G500/H210

SOLDER:Sn99.3-0.7-S002

3、 ELECTRICAL STRUCTURE



4、 ELECTRICAL CHARACTERISTICS:

TURNS : 1-4=2-3=20.0TS(Typ)

TEST FREQUENCY : 10KHz/0.1V(TH2776B)

INDUCTANCE : 1-4=2-3=14.25mH±30%

RDC : 1-4=2-3=0.020Ω Max

INSULATION RES : (1-2) 100 MΩ Min@500VDC

HI-POT TEST : (1-2)2500V/DC 1mA/5Sec